

LNJ727W83RAA

Surface Mounting Chip LED

USS-3 Type

■ Absolute Maximum Ratings $T_a = 25^\circ\text{C}$

- Pure Green

Parameter	Symbol	Rating	Unit
Power dissipation	P_D	65	mW
Forward current	I_F	15	mA
Pulse forward current *	I_{FP}	50	mA
Reverse direct current	I_{RDC}	100	mA
Operating ambient temperature	T_{opr}	-30 to +85	$^\circ\text{C}$
Storage temperature	T_{stg}	-40 to +100	$^\circ\text{C}$

Note) *: The condition of I_{FP} is duty 10%, Pulse width 1 msec.

- Orange

Parameter	Symbol	Rating	Unit
Power dissipation	P_D	55	mW
Forward current	I_F	20	mA
Pulse forward current *	I_{FP}	60	mA
Reverse voltage	V_R	4	V
Operating ambient temperature	T_{opr}	-30 to +85	$^\circ\text{C}$
Storage temperature	T_{stg}	-40 to +100	$^\circ\text{C}$

Note) *: The condition of I_{FP} is duty 10%, Pulse width 1 msec.

- Blue

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Power dissipation	P_D	65	mW
Forward current	I_F	15	mA
Pulse forward current *	I_{FP}	50	mA
Reverse direct current	I_{RDC}	100	mA
Operating ambient temperature	T_{opr}	-30 to +85	$^\circ\text{C}$
Storage temperature	T_{stg}	-40 to +100	$^\circ\text{C}$

Note) *: The condition of I_{FP} is duty 10%, Pulse width 1 msec.

■ Electro-Optical Characteristics $T_a = 25^\circ\text{C} \pm 3^\circ\text{C}$

- Pure Green

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Luminous intensity *1	I_O	$I_F = 5 \text{ mA}$	60	80	120	mcd
Forward voltage	V_F	$I_F = 5 \text{ mA}$		3.1	3.8	V
Peak emission wavelength	λ_p	$I_F = 5 \text{ mA}$		525		nm
Dominant emission wavelength *2	λ_d	$I_F = 5 \text{ mA}$	525	535	550	nm
Spectral half band width	$\Delta\lambda$	$I_F = 5 \text{ mA}$		45		nm

Note) *1: Measurement tolerance: $\pm 20\%$ *2: Measurement tolerance: $\pm 3 \text{ nm}$

■ Electro-Optical Characteristics (Continued) $T_a = 25^\circ\text{C} \pm 3^\circ\text{C}$

• Orange

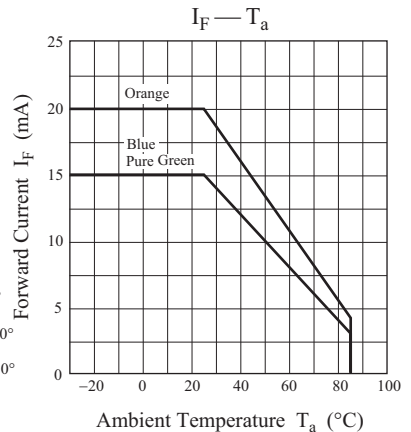
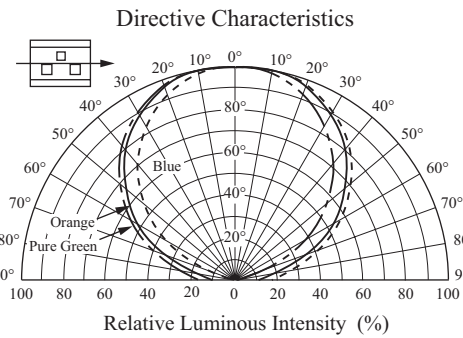
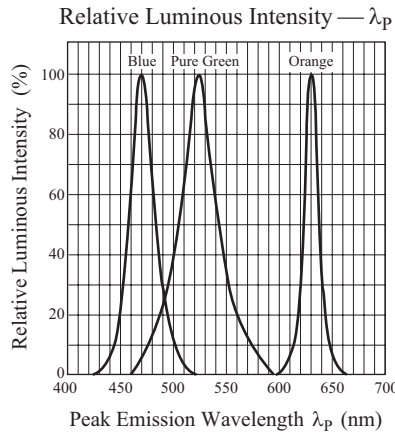
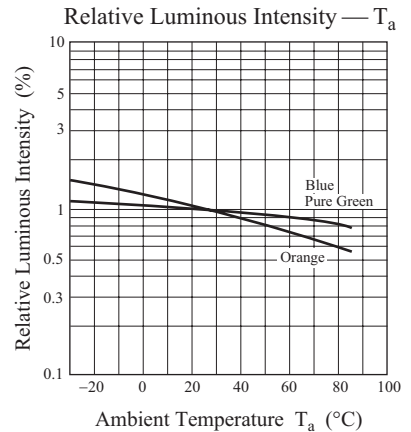
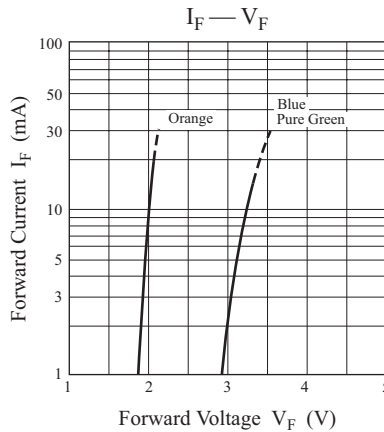
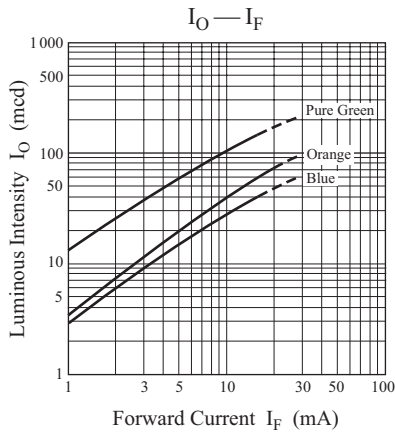
Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Luminous intensity *1	I_O	$I_F = 10 \text{ mA}$	20	40	80	mcd
Reverse current	I_R	$V_R = 4 \text{ V}$			100	μA
Forward voltage	V_F	$I_F = 10 \text{ mA}$		2.0	2.5	V
Peak emission wavelength	λ_p	$I_F = 10 \text{ mA}$		630		nm
Dominant emission wavelength *2	λ_d	$I_F = 10 \text{ mA}$	610	620	630	nm
Spectral half band width	$\Delta\lambda$	$I_F = 10 \text{ mA}$		15		nm

Note) *1: Measurement tolerance: $\pm 20\%$
 *2: Measurement tolerance: $\pm 3 \text{ nm}$

• Blue

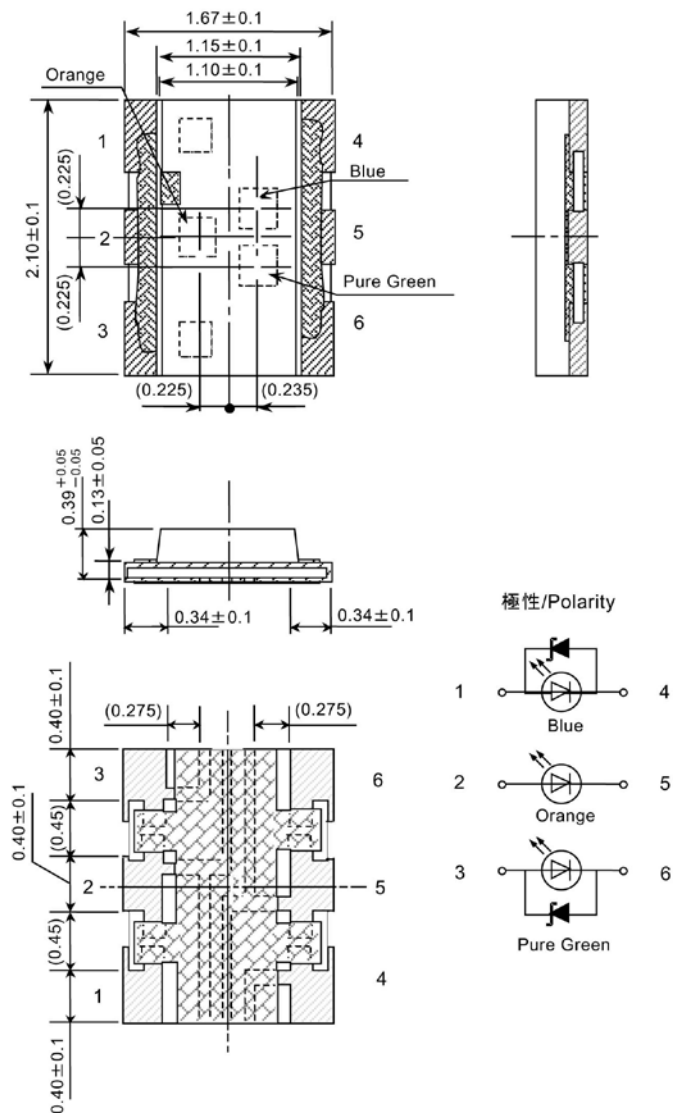
Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Luminous intensity *1	I_O	$I_F = 5 \text{ mA}$	5	15	35	mcd
Forward voltage	V_F	$I_F = 5 \text{ mA}$		3.1	3.8	V
Peak emission wavelength	λ_p	$I_F = 5 \text{ mA}$		470		nm
Dominant emission wavelength *2	λ_d	$I_F = 5 \text{ mA}$	465	472	480	nm
Spectral half band width	$\Delta\lambda$	$I_F = 5 \text{ mA}$		30		nm

Note) *1: Measurement tolerance: $\pm 20\%$
 *2: Measurement tolerance: $\pm 3 \text{ nm}$



■ Package (Unit: mm)

KLTFTN6K2740



- Pin name
1, 2, 3: Anode
4, 5, 6: Cathode

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